

101535725

2005 RUEP POMO 20 MAY 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

FELBER et al.

Application No.:

Group Art Unit:

Filing

Examiner: unk.

Date: unk

Attorney Docket No.: 81,617

For: "Improved Molded Foams"

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

Pursuant to Applicants' duty of disclosure under 37 C.F.R. § 1.56 and § 1.97(h), enclosed is a List of References Cited By Applicant, which lists 3 references, all of which are US Patents.

No fee is believed to be due for this submission pursuant to 37 C.F.R. § 1.97(c), because there has not been an Office Action in this case. In the event a fee is deemed due, the Commissioner is hereby authorized to charge any needed fee in connection with this matter to Deposit Account 08-3442.

Thus, it is respectfully requested that these references be made of record in this application.

Respectfully submitted,



Date May 19, 2005

Christopher J. Whewell
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LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)		ATTY. DOCKET NO. 81,617	APPLICATION NO. 10h/535725
		APPLICANT FELBER et al.	
TITLE Improved Molded Foams		FILING DATE unk.	GROUP unk.

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
/J.C./	5,096,993	03/17/92	Smith et al.	528	61	
/J.C./	5,100,997	03/31/92	Reisch et al.	528	60	
/J.C./	5,185,420	02/09/93	Smith et al.	528	61	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
							YES
							NO

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER	/John Cooney/	DATE CONSIDERED	03/28/2008
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.